IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 3064

Hiroaki INOUE et al.

Docket No. 2001 1094A

Serial No. 09/890,455

Group Art Unit 2812

Filed March 12, 2002

Examiner Lynne A. Gurley

ELECTROLESS PLATING LIQUID AND METHOD OF FORMING INTERCONNECTION USING SUCH AN ELECTROLESS PLATING LIQUID

LETTER RE PROPOSED DRAWING AMENDMENTS

Assistant Commissioner for Patents, Washington, D.C.

Sir:

Enclosed herewith is a photocopy of Fig. 2 marked in red to indicate proposed drawing amendment thereto.

The Examiner is requested to approve such proposed drawing amendment, and after allowance of this application, formal drawing incorporating such amendment will be filed.

Respectfully submitted,

Hiroaki INOUE et al.

By

Warren M. Cheek, J.

Registration No. 33,367

Attorney for Applicants

WMC/dlk Washington, D.C. 20006-1021 Telephone (202) 721-8200 Facsimile (202) 721-8250 March 31, 2003

System System